

FTP03N06NA

 I_{D}

230A

D

s

Lead Free Package and Finish

R_{DS(ON)}(Typ.)

3mΩ

G

N-Channel MOSFET

Applications:

- Adaptor
- Charger
- .SMPS

Features:

- RoHS Compliant
- . Low ON Resistance
- Low Gate Charge
- Peak Current vs Pulse Width Curve
- Inductive Switching Curves

Ordering Information

PART NUMBER	UMBER PACKAGE			
FTP03N06NA	TO-220	IPS		

Absolute Maximum Ratings

 $T_{C}=25^{\circ}C$ unless otherwise specified

Pb

TO-220

Packages Not to Scale

 V_{DSS}

60V

Symbol	Parameter	FTP03N06NA	Units
V _{DSS}	Drain-to-Source Voltage	60	V
I _D	Continuous Drain Current	230	А
	Continuous Drain Current $T_C = 100^{\circ}C$	145	А
I _{DM}	Pulsed Drain Current (NOTE *1)	920	А
р	Power Dissipation	284	W
P _D	Derating Factor above 25°C	2.272	W/℃
V _{GS}	Gate-to-Source Voltage	±20	V
E _{AS}	Single Pulse Avalanche Energy(NOTE *2)	1024	mJ
TL	Maximum Temperature for Soldering	300	
$T_{\rm J}$ and $T_{\rm STG}$	Operating Junction and Storage Temperature Range	150,-55 to150	Ĉ

GDS

Thermal Resistance

Symbol	Parameter	Max.	Units	Test Conditions
$R_{ extsf{ heta}JC}$	Junction-to-Case	0.44	°C/W	Water cooled heatsink, P_D adjusted for a peak junction temperature of +150°C.
R _{eja}	Junction-to-Ambient	62.5		1 cubic foot chamber, free air.

OFF Characteristics $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	60			V	V _{GS} =0V, I _D =250µA
I _{DSS}	Drain-to-Source Leakage Current			1	μA	V _{DS} =60V, V _{GS} =0V
						T J=25 ℃
				100		V _{DS} =48V, V _{GS} =0V
						T 」=125 ℃
I _{GSS}	Gate-to-Source Forward Leakage			+100	nA	V_{GS} =+20V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V

ON Characteristics $T_J=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
R _{DS(ON)}	StaticDrain-to-Source On-Resistance		3.0	3.6	mΩ	V _{GS} =10V, I _D =95A	
V _{GS(TH)}	Gate Threshold Voltage	2		4	V	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	
Pulse width <	Pulse width ≤300µs; duty cycle≤ 2%						

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
R _g	Gate resistance		1.3		Ω	V_{GS} = 0V, V_{DS} = 25V f =1.0MHz
C _{iss}	Input Capacitance		5681		pF	V_{GS} = 0V, V_{DS} = 25V f =1.0MHz
C _{oss}	Output Capacitance		734.8			
C _{rss}	Reverse Transfer Capacitance		371.5			
Q _g (10V)	Total Gate Charge		98.4			
Q _{gs}	Gate-to-Source Charge		29		nC	I _D =115A,V _{DD} =48V V _{GS} = 10V
Q _{gd}	Gate-to-Drain ("Miller") Charge		33.2			$v_{GS} = 10V$

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
t _{d(ON)}	Turn-on Delay Time		41.9			V_{DD} =30V, I _D =115A, V _G =10V R _G =6Ω
t _{rise}	Rise Time		47			
t _{d(OFF)}	Turn-Off Delay Time		70.9		ns	
t _{fall}	Fall Time		29.3			



Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	Continuous Source Current			230	А	T _C =25℃
I _S	(Body Diode)					
I _{SM}	Maximum Pulsed Current			920	A	
	(Body Diode)					
V _{SD}	Diode Forward Voltage			1.5	V	I _{SD} =95A, V _{GS} =0V
t _{rr}	Reverse Recovery Time		38.1		ns	I _F = 115A
Q _{rr}	Reverse Recovery Charge		51.9		nC	di/dt=100A/us
Pulse width	\leq 300µs; duty cycle $\leq 2\%$	•		•	•	

Source-Drain Diode Characteristics Tc=25°C unless otherwise specified

Notes:

*1. Repetitive rating; pulse width limited by maximum junction temperature.

*2. L=0.5mH, I_D =64A, Start T_J=25 $^{\circ}$ C



Characteristics Curve:

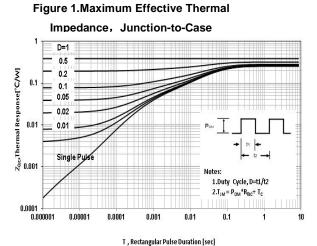
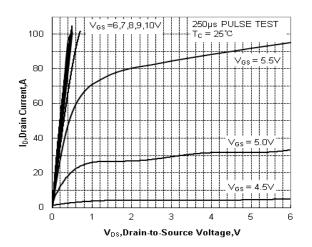
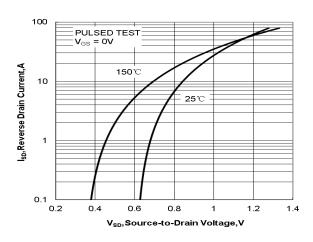


Figure 3. Typical Output Characteristics







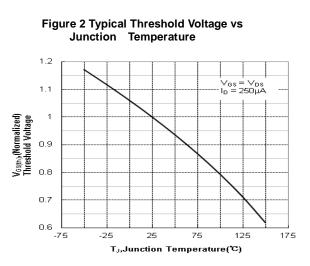


Figure 4. Typical Transfer Characteristics

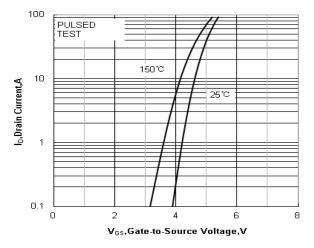


Figure 6. Typical on Resistance VS Drain Current

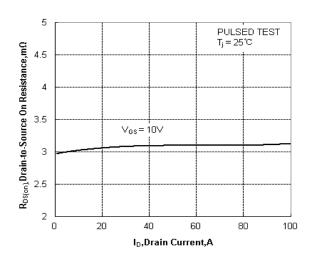




Figure 7. Capacitance VS Drain-to-Source Voltage

Figure 8. Gate Charge VS Gate-to-Source Voltage

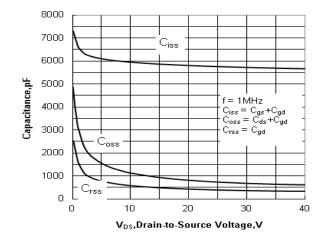
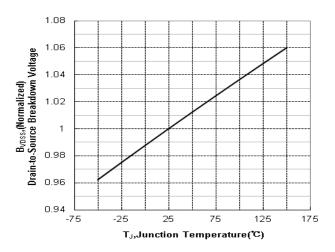
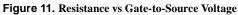
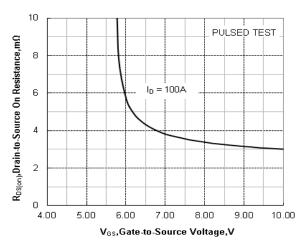


Figure 9. Breakdown Voltage VS Temperature







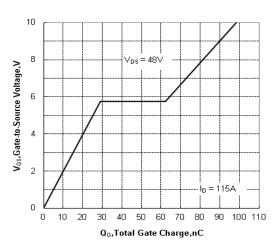
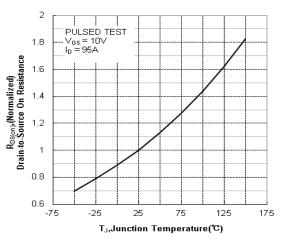
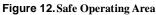


Figure 10. on-Resistance VS Temperature





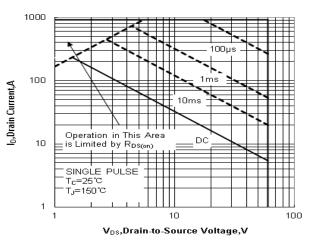
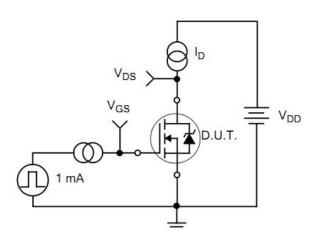




Figure 14. Gate Charge Waveforms

Test Circuits and Waveforms

Figure 13. Gate Charge Test Circuit



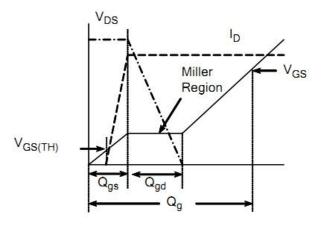
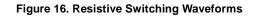
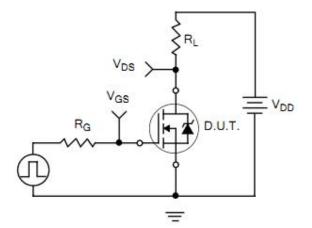
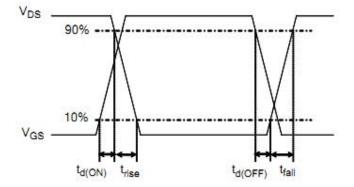


Figure 15. Resistive Switching Test Circuit





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di/dt=100A/µs+

Figure 18. Diode Reverse Recovery Waveform

Figure 17. Diode Reverse Recovery Test Circuit

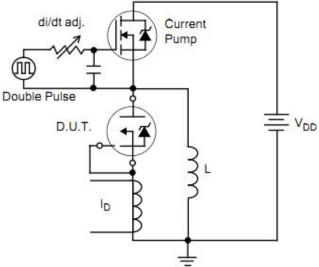


Figure19.Unclamped Inductive Switching Test Circuit

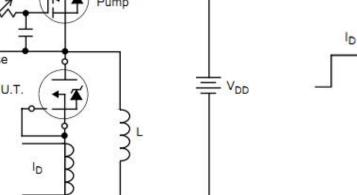
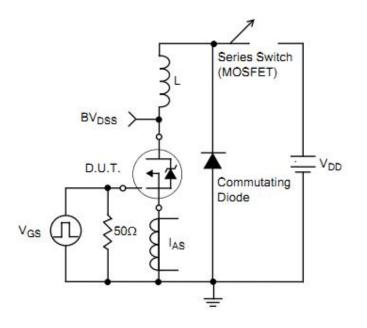
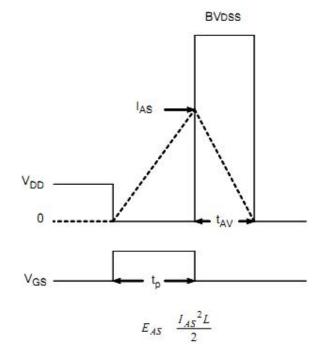


Figure 20. Unclamped Inductive Switching Waveform





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